

TOSHIBA CDMOS Integrated Circuit Silicon Monolithic

TC62D748CFG

16-Output Constant Current LED Driver

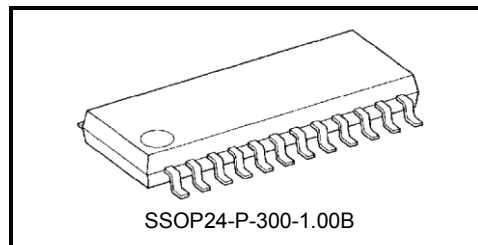
The TC62D748CFG is a constant-current driver for LED and LED display lighting applications.

The output current from each of the 16 outputs is programmable via a single external resistor.

The TC62D748CFG contains a 16-channel shift register, a 16-channel latch, a 16-channel AND gate and a 16-channel constant-current output.

Fabricated with a CMOS process, the TC62D748CFG allows high-speed data transfer.

It operates with a 3.3- or 5-V power supply.



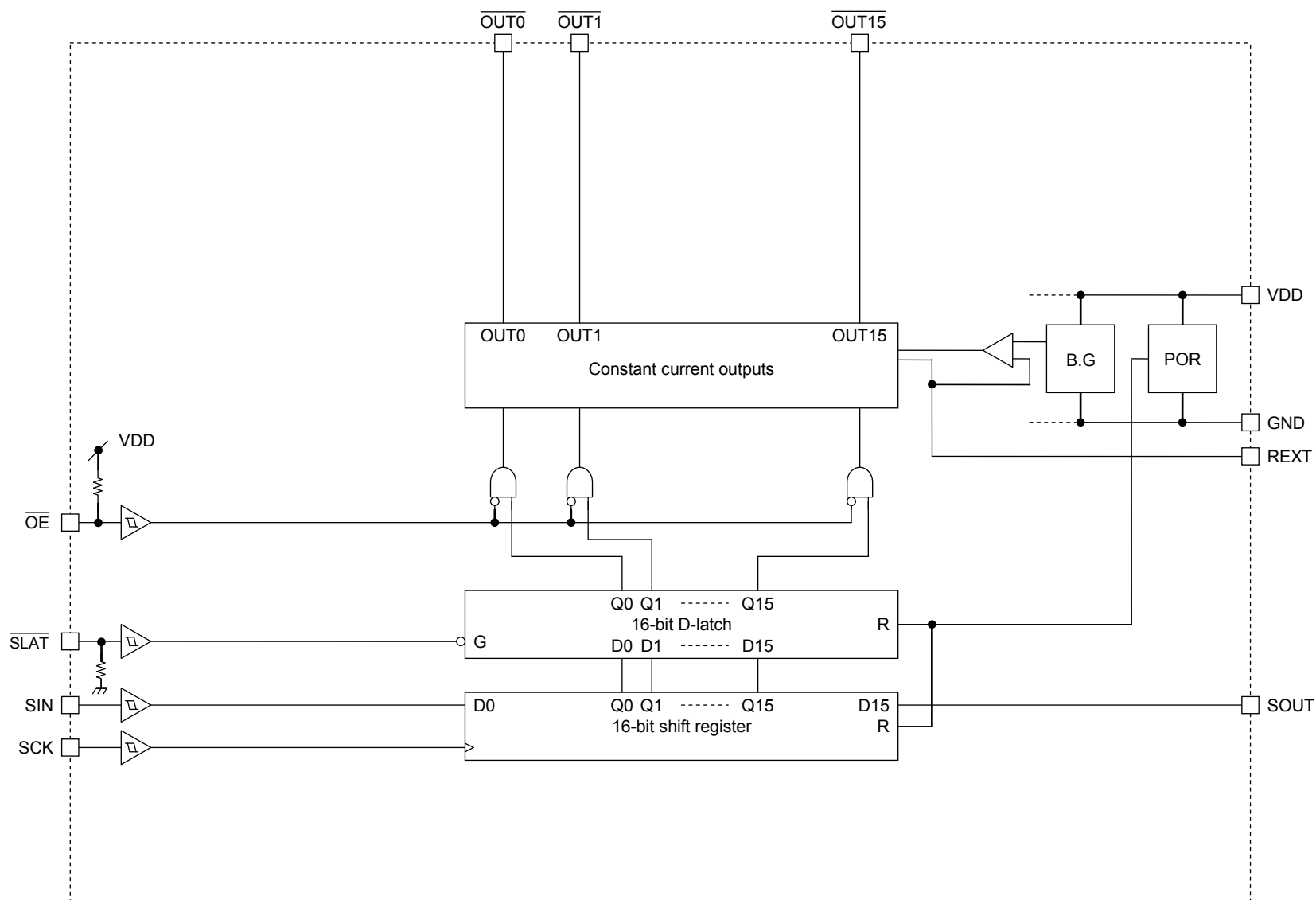
Weight: 0.29 g (Typ.)

Features

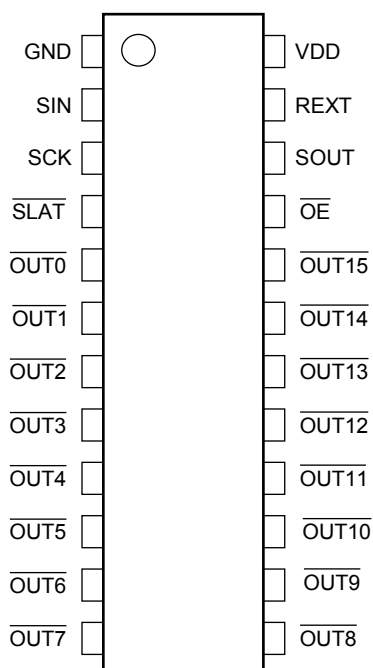
- Supply voltages : $V_{DD} = 3.0\text{ V to }5.5\text{ V}$
- 16-output built-in
- Output current setup range : $I_{OUT} = 1.5\text{ to }90\text{ mA}$
- Constant current output accuracy (@ $R_{EXT} = 1.2\text{ k}\Omega$, $V_{OUT} = 1.0\text{ V}$, $V_{DD} = 3.3\text{ V}, 5.0\text{ V}$)
 - : S rank ; between outputs $\pm 1.5\%$ (max)
 - : S rank ; between devices: $\pm 1.5\%$ (max)
 - : N rank ; between outputs $\pm 2.5\%$ (max)
 - : N rank ; between devices: $\pm 2.5\%$ (max)
- Output voltage : $V_{OUT} = 17\text{ V (max)}$
- High-speed output switching : $t_{wOE(L)} = 25\text{ ns (min)}$, $t_{or} = 30\text{ ns (typ.)}$, $t_{of} = 10\text{ ns (typ.)}$
 There is TC62D749 as an output switching high-speed version of this product.
- I/O interface : CMOS interfaces (Schmitt trigger input)
- Data transfer frequency : $f_{SCK} = 25\text{ MHz (max)}$
- Operation temperature range : $T_{opr} = -40\text{ to }85\text{ }^{\circ}\text{C}$
- Power-on-reset function built-in. (When the power supply is turned on, internal data is reset)
- Package : SSOP24-P-300-1.00B

For detailed part naming conventions, contact your local Toshiba sales representative or distributor.

Block Diagram



Pin Assignment (top view)



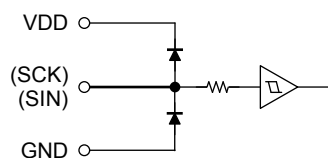
Short circuiting an output pin to a power supply pin (Power-supply voltage V_{DD} and LED anode power supply), or short-circuiting the REXT pin to the GND pin will likely exceed the absolute maximum rating, which in turn may result in smoldering and/or permanent damage. Please keep this in mind when determining the wiring layout for the power supply and GND pins.

Pin Functions

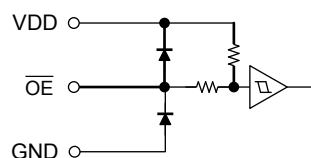
Pin No	Pin Name	I/O	Function
1	GND	—	GND terminal
2	SIN	I	Serial data input terminal
3	SCK	I	Serial data transfer clock input terminal
4	$\overline{\text{SLAT}}$	I	Latch signal input pin.
5	$\overline{\text{OUT0}}$	O	Constant-current output terminal
6	$\overline{\text{OUT1}}$	O	Constant-current output terminal
7	$\overline{\text{OUT2}}$	O	Constant-current output terminal
8	$\overline{\text{OUT3}}$	O	Constant-current output terminal
9	$\overline{\text{OUT4}}$	O	Constant-current output terminal
10	$\overline{\text{OUT5}}$	O	Constant-current output terminal
11	$\overline{\text{OUT6}}$	O	Constant-current output terminal
12	$\overline{\text{OUT7}}$	O	Constant-current output terminal
13	$\overline{\text{OUT8}}$	O	Constant-current output terminal
14	$\overline{\text{OUT9}}$	O	Constant-current output terminal
15	$\overline{\text{OUT10}}$	O	Constant-current output terminal
16	$\overline{\text{OUT11}}$	O	Constant-current output terminal
17	$\overline{\text{OUT12}}$	O	Constant-current output terminal
18	$\overline{\text{OUT13}}$	O	Constant-current output terminal
19	$\overline{\text{OUT14}}$	O	Constant-current output terminal
20	$\overline{\text{OUT15}}$	O	Constant-current output terminal
21	$\overline{\text{OE}}$	I	An output current enable signal input terminal In "H" level input, outputs are turned off compulsorily. In "L" level input, outputs are ON/OFF controlled according to serial data.
22	SOUT	O	Serial data output terminal.
23	REXT	—	An external resistance for an output current setup is connected between this terminal and ground.
24	VDD	—	Power supply terminal

I/O Equivalent Circuits

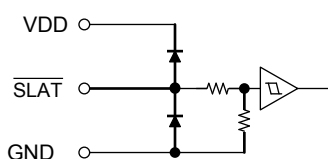
1. SCK, SIN



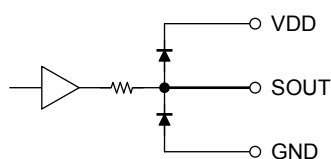
2. $\overline{\text{OE}}$



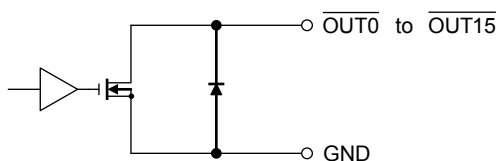
3. $\overline{\text{SLAT}}$



4. SOUT



5. $\overline{\text{OUT0}}$ to $\overline{\text{OUT15}}$



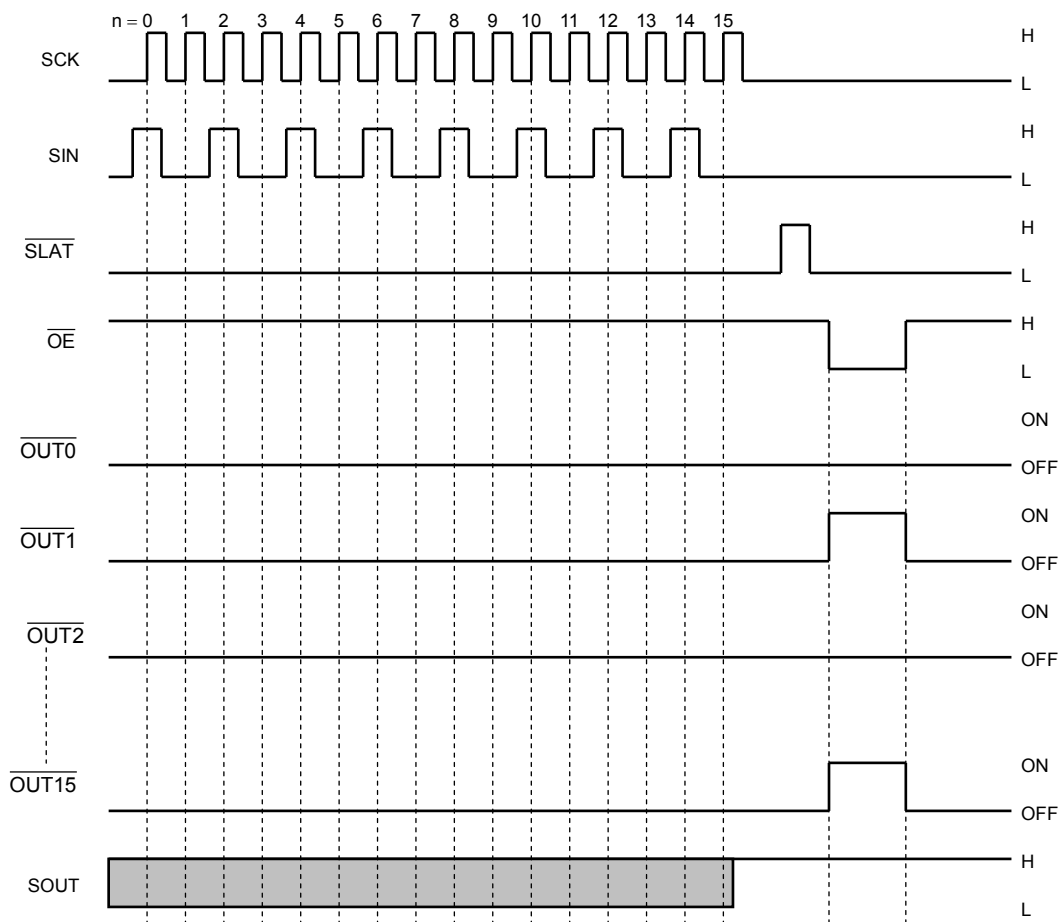
Truth Table

SCK	$\overline{\text{SLAT}}$	$\overline{\text{OE}}$	SIN	$\overline{\text{OUT0}} \dots \overline{\text{OUT7}} \dots \overline{\text{OUT15}}$ (Note1)	SOUT
	H	L	Dn	Dn ... Dn - 7 ... Dn - 15	Dn - 15
	L	L	Dn + 1	No Change	Dn - 14
	H	L	Dn + 2	Dn + 2 ... Dn - 5 ... Dn - 13	Dn - 13
	– (Note2)	L	Dn + 3	Dn + 2 ... Dn - 5 ... Dn - 13	Dn - 13
	– (Note2)	H	Dn + 3	OFF	Dn - 13

Note1: When $\overline{\text{OUT0}}$ to $\overline{\text{OUT15}}$ output pins are set to "H" the respective output will be ON and when set to "L" the respective output will be OFF.

Note2: "–" is irrelevant to the truth table.

Timing Diagram



- The latch circuit is a leveled-latch circuit. Please exercise precaution as it is not triggered-latch circuit.
- Keep the $\overline{\text{SLAT}}$ pin is set to "L" to enable the latch circuit to hold data. In addition, when the $\overline{\text{SLAT}}$ pin is set to "H" the latch circuit does not hold data. The data will instead pass onto output. When the $\overline{\text{OE}}$ pin is set to "L" the $\overline{\text{OUT0}}$ to $\overline{\text{OUT15}}$ output pins will go ON and OFF in response to the data. In addition, when the $\overline{\text{OE}}$ pin is set to "H" all the output pins will be forced OFF regardless of the data.
- This product can use 3.3V and 5.0V power supply, but power supply and input (SCK/SIN/ $\overline{\text{SLAT}}$ / $\overline{\text{OE}}$) must use same voltage.

Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

Characteristics	Symbol	Rating (Note1)	Unit
S u p p l y v o l t a g e	V_{DD}	-0.3 to 6.0	V
O u t p u t c u r r e n t	I_{OUT}	95	mA
L o g i c i n p u t v o l t a g e	V_{IN}	-0.3 to $V_{DD} + 0.3$ (Note2)	V
O u t p u t v o l t a g e	V_{OUT}	-0.3 to 17	V
O p e r a t i n g t e m p e r a t u r e	T_{opr}	-40 to 85	$^\circ\text{C}$
S t o r a g e t e m p e r a t u r e	T_{stg}	-55 to 150	$^\circ\text{C}$
T h e r m a l r e s i s t a n c e	$R_{th(j-a)}$	94 (Note3)	$^\circ\text{C/W}$
P o w e r d i s s i p a t i o n	P_D	1.32 (Note3, 4)	W

Note1: Voltage is ground referenced.

Note2: Do not exceed 6.0V.

Note3: PCB condition 76.2 x 114.3 x 1.6 mm, Cu 30% (SEMI conforming)

Note4: The power dissipation decreases the reciprocal of the saturated thermal resistance ($1/R_{th(j-a)}$) for each degree (1°C) that the ambient temperature is exceeded ($T_a = 25^\circ\text{C}$).**Operating Conditions****DC Items (Unless otherwise specified, $V_{DD} = 3.0$ to 5.5 V, $T_a = -40^\circ\text{C}$ to 85°C)**

Characteristics	Symbol	Test Conditions	Min	Typ.	Max	Unit
S u p p l y v o l t a g e	V_{DD}	—	3.0	—	5.5	V
High level logic input voltage	V_{IH}	Test terminal are SIN,SCK, $\overline{\text{SLAT}}$, $\overline{\text{OE}}$	$0.7 \times V_{DD}$	—	V_{DD}	V
Low level logic input voltage	V_{IL}	Test terminal are SIN,SCK, $\overline{\text{SLAT}}$, $\overline{\text{OE}}$	GND	—	$0.3 \times V_{DD}$	V
High level SOUT output current	I_{OH}	—	—	—	-1	mA
Low level SOUT output current	I_{OL}	—	—	—	1	mA
Constant current output	I_{OUT}	Test terminal is $\overline{\text{OUTn}}$	1.5	—	90	mA

AC Items (Unless otherwise specified, $V_{DD} = 3.0$ to 5.5 V, $T_a = -40^\circ\text{C}$ to 85°C)

Characteristics	Symbol	Test Circuits	Test Conditions	Min	Typ.	Max	Unit
Serial data transfer frequency	f_{SCK}	6	—	—	—	25	MHz
Serial data Hold time	t_{HOLD1}	6	—	5	—	—	ns
	t_{HOLD2}	6	—	5	—	—	ns
Serial data Setup time	t_{SETUP1}	6	—	5	—	—	ns
	t_{SETUP2}	6	—	5	—	—	ns
Maximum clock rise time	t_r	6	(Note1)	—	—	500	ns
Maximum clock fall time	t_f	6	(Note1)	—	—	500	ns

Note1: If the device is connected in a cascade and the t_r/t_f of the clock waveform increases due to deceleration of the clock waveform, it may not be possible to achieve the timing required for data transfer. Please keep these timing conditions in mind when designing your application.

Electrical Characteristics (Unless otherwise specified, $V_{DD} = 3.3V$, $T_a = 25^\circ C$)

Characteristics	Symbol	Test Circuits	Test Conditions	Min	Typ.	Max	Unit
H i g h l e v e l S O U T o u t p u t v o l t a g e	V_{OH}	1	$I_{OH} = -1 \text{ mA}$	$V_{DD} - 0.4$	—	—	V
L o w l e v e l S O U T o u t p u t v o l t a g e	V_{OL}	1	$I_{OL} = +1 \text{ mA}$	—	—	0.4	V
High level logic input current	I_{IH}	2	$V_{IN} = V_{DD}, \overline{OE}, \text{SIN}, \text{SCK}$	—	—	1	μA
Low level logic input current	I_{IL}	3	$V_{IN} = \text{GND}, \overline{SLAT}, \text{SIN}, \text{SCK}$	—	—	-1	μA
Power supply current	I_{DD}	4	$R_{EXT} = 1.2 \text{ k}\Omega$, All output on	—	—	8.0	mA
O u t p u t c u r r e n t	I_{OUT}	5	$V_{OUT} = 1.0 \text{ V}$, $R_{EXT} = 1.2 \text{ k}\Omega$, 1 output on	—	14.4	—	mA
Constant current error(Ch to Ch) (S r a n k)	$\Delta I_{OUT(Ch)}$	5	$V_{OUT} = 1.0 \text{ V}$, $R_{EXT} = 1.2 \text{ k}\Omega$, 1 output on	—	—	± 1.5	%
Constant current error(IC to IC) (S r a n k)	$\Delta I_{OUT(IC)}$	5	$V_{OUT} = 1.0 \text{ V}$, $R_{EXT} = 1.2 \text{ k}\Omega$, 1 output on	—	—	± 1.5	%
Constant current error(Ch to Ch) (N r a n k)	$\Delta I_{OUT(Ch)}$	5	$V_{OUT} = 1.0 \text{ V}$, $R_{EXT} = 1.2 \text{ k}\Omega$, 1 output on	—	—	± 2.5	%
Constant current error(IC to IC) (N r a n k)	$\Delta I_{OUT(IC)}$	5	$V_{OUT} = 1.0 \text{ V}$, $R_{EXT} = 1.2 \text{ k}\Omega$, 1 output on	—	—	± 2.5	%
Output OFF leak current	I_{OK}	5	$V_{OUT} = 17 \text{ V}$, $R_{EXT} = 1.2 \text{ k}\Omega$	—	—	0.5	μA
Constant current output power supply v o l t a g e r e g u l a t i o n	$\%V_{DD}$	5	$V_{DD} = 3.0 \text{ to } 3.6 \text{ V}$, $V_{OUT} = 1.0 \text{ V}$, $R_{EXT} = 1.2 \text{ k}\Omega$, 1 output on	—	± 1	± 5	%/V
Constant current output output voltage r e g u l a t i o n	$\%V_{OUT}$	5	$V_{OUT} = 1.0 \text{ to } 3.0 \text{ V}$, $R_{EXT} = 1.2 \text{ k}\Omega$, 1 output on	—	± 0.1	± 0.5	%/V
P u l l - u p r e s i s t o r	$R_{(Up)}$	3	$\overline{OE}$	400	500	600	$\text{k}\Omega$
P u l l - d o w n r e s i s t o r	$R_{(Down)}$	2	$\overline{SLAT}$	400	500	600	$\text{k}\Omega$

Electrical Characteristics (Unless otherwise specified, $V_{DD} = 5.0V$, $T_a = 25^\circ C$)

Characteristics	Symbol	Test Circuits	Test Conditions	Min	Typ.	Max	Unit
H i g h l e v e l S O U T o u t p u t v o l t a g e	V_{OH}	1	$I_{OH} = -1 \text{ mA}$	$V_{DD} - 0.4$	—	—	V
L o w l e v e l S O U T o u t p u t v o l t a g e	V_{OL}	1	$I_{OL} = +1 \text{ mA}$	—	—	0.4	V
High level logic input current	I_{IH}	2	$V_{IN} = V_{DD}, \overline{OE}, \text{SIN}, \text{SCK}$	—	—	1	μA
Low level logic input current	I_{IL}	3	$V_{IN} = \text{GND}, \overline{\text{SLAT}}, \text{SIN}, \text{SCK}$	—	—	-1	μA
Power supply current	I_{DD}	4	$R_{EXT} = 1.2 \text{ k}\Omega$, All output on	—	—	8.0	mA
O u t p u t c u r r e n t	I_{OUT}	5	$V_{OUT} = 1.0 \text{ V}$, $R_{EXT} = 1.2 \text{ k}\Omega$, 1 output on	—	14.4	—	mA
Constant current error(Ch to Ch) (S r a n k)	$\Delta I_{OUT(Ch)}$	5	$V_{OUT} = 1.0 \text{ V}$, $R_{EXT} = 1.2 \text{ k}\Omega$, 1 output on	—	—	± 1.5	%
Constant current error(IC to IC) (S r a n k)	$\Delta I_{OUT(IC)}$	5	$V_{OUT} = 1.0 \text{ V}$, $R_{EXT} = 1.2 \text{ k}\Omega$, 1 output on	—	—	± 1.5	%
Constant current error(Ch to Ch) (N r a n k)	$\Delta I_{OUT(Ch)}$	5	$V_{OUT} = 1.0 \text{ V}$, $R_{EXT} = 1.2 \text{ k}\Omega$, 1 output on	—	—	± 2.5	%
Constant current error(IC to IC) (N r a n k)	$\Delta I_{OUT(IC)}$	5	$V_{OUT} = 1.0 \text{ V}$, $R_{EXT} = 1.2 \text{ k}\Omega$, 1 output on	—	—	± 2.5	%
Output OFF leak current	I_{OK}	5	$V_{OUT} = 17 \text{ V}$, $R_{EXT} = 1.2 \text{ k}\Omega$	—	—	0.5	μA
Constant current output power supply v o l t a g e r e g u l a t i o n	$\%V_{DD}$	5	$V_{DD} = 4.5 \text{ to } 5.5 \text{ V}$, $V_{OUT} = 1.0 \text{ V}$, $R_{EXT} = 1.2 \text{ k}\Omega$, 1 output on	—	± 1	± 5	%/V
Constant current output output voltage r e g u l a t i o n	$\%V_{OUT}$	5	$V_{OUT} = 1.0 \text{ to } 3.0 \text{ V}$, $R_{EXT} = 1.2 \text{ k}\Omega$, 1 output on	—	± 0.1	± 0.5	%/V
P u l l - u p r e s i s t o r	$R_{(Up)}$	3	$\overline{OE}$	400	500	600	$\text{k}\Omega$
P u l l - d o w n r e s i s t o r	$R_{(Down)}$	2	$\overline{\text{SLAT}}$	400	500	600	$\text{k}\Omega$

Switching Characteristics (Unless otherwise specified, $V_{DD} = 3.3V$, $T_a = 25^\circ C$)

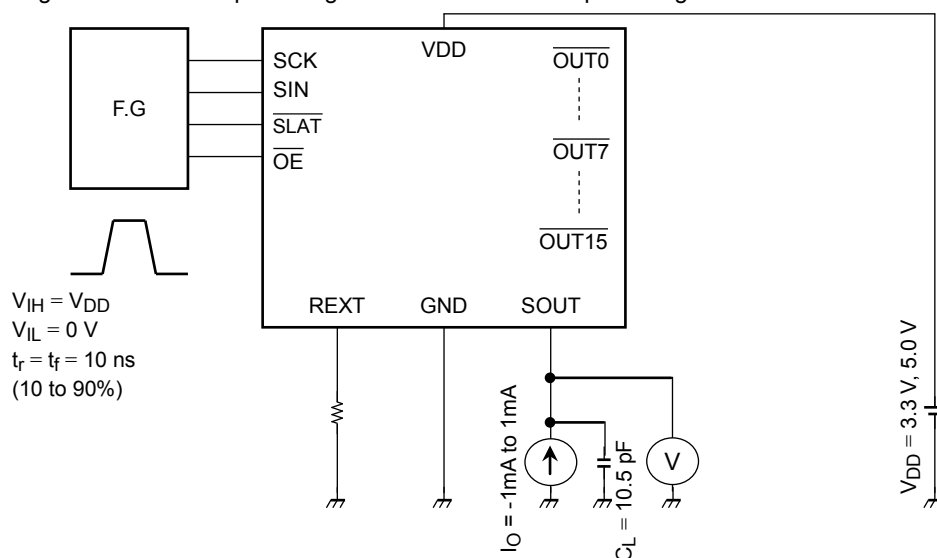
Characteristics		Symbol	Test Circuits	Test Conditions	Min	Typ.	Max	Unit
Propagation delay t _i m e	SCK- $\overline{\text{OUT0}}$	t _{pLH1}	6	$\overline{\text{SLAT}}$ = “H”, $\overline{\text{OE}}$ = “L”	—	50	65	ns
	$\overline{\text{SLAT}}$ - $\overline{\text{OUT0}}$	t _{pLH2}	6	$\overline{\text{OE}}$ = “L”	—	50	65	ns
	$\overline{\text{OE}}$ - $\overline{\text{OUT0}}$	t _{pLH3}	6	$\overline{\text{SLAT}}$ = “H”	—	50	65	ns
	SCK-SOUT	t _{pLH}	6	C _L =10.5 pF	10	20	35	ns
	SCK- $\overline{\text{OUT0}}$	t _{pHL1}	6	$\overline{\text{SLAT}}$ = “H”, $\overline{\text{OE}}$ = “L”	—	30	40	ns
	$\overline{\text{SLAT}}$ - $\overline{\text{OUT0}}$	t _{pHL2}	6	$\overline{\text{OE}}$ = “L”	—	30	40	ns
	$\overline{\text{OE}}$ - $\overline{\text{OUT0}}$	t _{pHL3}	6	$\overline{\text{SLAT}}$ = “H”	—	30	40	ns
	SCK-SOUT	t _{pHL}	6	CL=10.5 pF	10	20	35	ns
O u t p u t r i s e t i m e		t _{or}	6	10 to 90% of voltage waveform	—	30	45	ns
O u t p u t f a l l t i m e		t _{of}	6	90 to 10% of voltage waveform	—	10	20	ns
E n a b l e p u l s e w i d t h		t _{wOE(L)}	6	$\overline{\text{OE}}$ = “L”	25	—	—	ns
		t _{wOE(H)}	6	$\overline{\text{OE}}$ = “H”	50	—	—	
C l o c k p u l s e w i d t h		t _{wSCK}	6	SCK = “H” or “L”	20	—	—	ns
L a t c h p u l s e w i d t h		t _{wSLAT}	6	$\overline{\text{SLAT}}$ = “H”	20	—	—	ns

Switching Characteristics (Unless otherwise specified, $V_{DD} = 5.0V$, $T_a = 25^\circ C$)

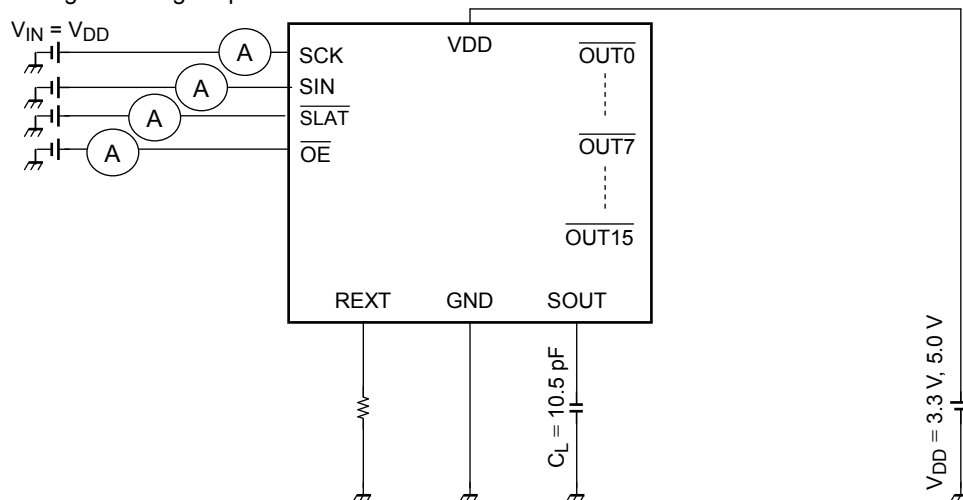
Characteristics		Symbol	Test Circuits	Test Conditions	Min	Typ.	Max	Unit
Propagation delay t _i m e	SCK- $\overline{\text{OUT0}}$	t _{pLH1}	6	$\overline{\text{SLAT}}$ = “H”, $\overline{\text{OE}}$ = “L”	—	50	65	ns
	$\overline{\text{SLAT}}$ - $\overline{\text{OUT0}}$	t _{pLH2}	6	$\overline{\text{OE}}$ = “L”	—	50	65	ns
	$\overline{\text{OE}}$ - $\overline{\text{OUT0}}$	t _{pLH3}	6	$\overline{\text{SLAT}}$ = “H”	—	50	65	ns
	SCK-SOUT	t _{pLH}	6	C _L =10.5 pF	10	20	35	ns
	SCK- $\overline{\text{OUT0}}$	t _{pHL1}	6	$\overline{\text{SLAT}}$ = “H”, $\overline{\text{OE}}$ = “L”	—	30	40	ns
	$\overline{\text{SLAT}}$ - $\overline{\text{OUT0}}$	t _{pHL2}	6	$\overline{\text{OE}}$ = “L”	—	30	40	ns
	$\overline{\text{OE}}$ - $\overline{\text{OUT0}}$	t _{pHL3}	6	$\overline{\text{SLAT}}$ = “H”	—	30	40	ns
	SCK-SOUT	t _{pHL}	6	C _L =10.5 pF	10	20	35	ns
O u t p u t r i s e t i m e		t _{or}	6	10 to 90% of voltage waveform	—	30	45	ns
O u t p u t f a l l t i m e		t _{of}	6	90 to 10% of voltage waveform	—	10	20	ns
E n a b l e p u l s e w i d t h		t _{wOE(L)}	6	$\overline{\text{OE}}$ = “L”	25	—	—	ns
		t _{wOE(H)}	6	$\overline{\text{OE}}$ = “H”	50	—	—	
C l o c k p u l s e w i d t h		t _{wSCK}	6	SCK = “H” or “L”	20	—	—	ns
L a t c h p u l s e w i d t h		t _{wSLAT}	6	$\overline{\text{SLAT}}$ = “H”	20	—	—	ns

Test Circuits

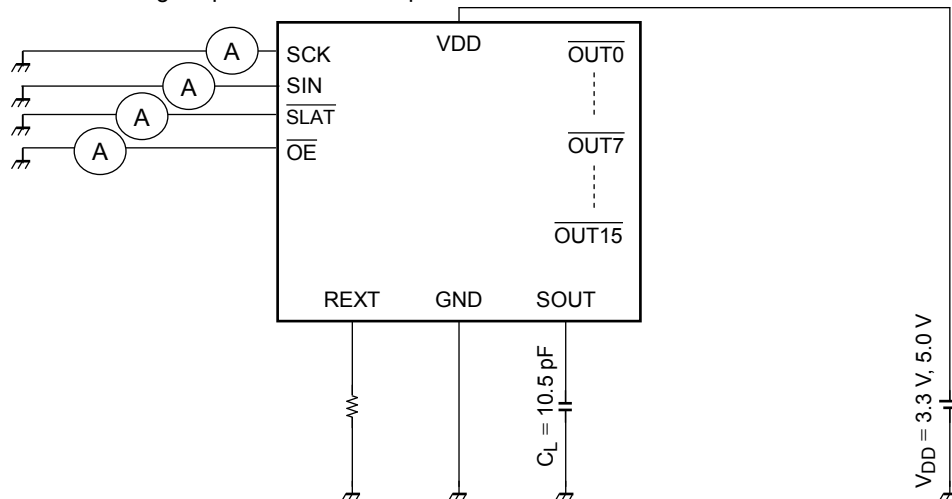
Test Circuit1: High level SOUT output voltage / Low level SOUT output voltage



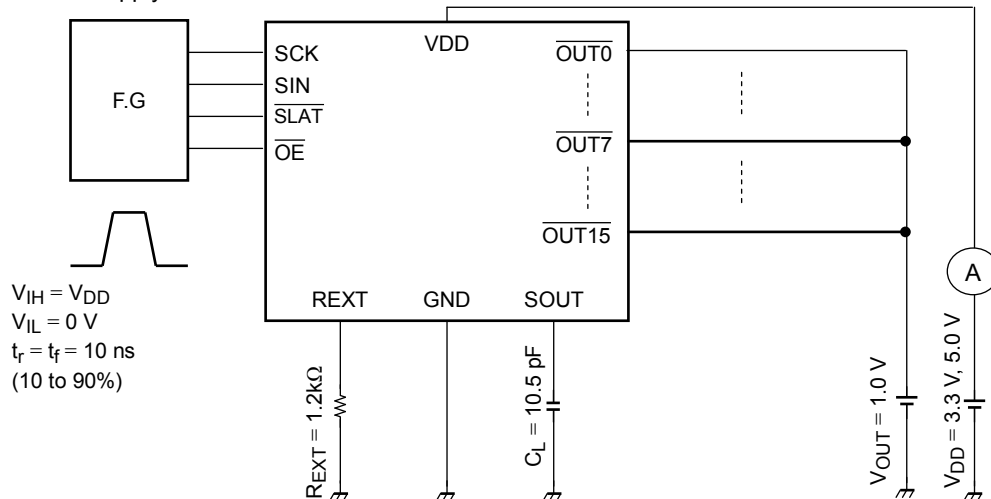
Test Circuit2: High level logic input current / Pull-down resistor



Test Circuit3: Low level logic input current / Pull-up resistor

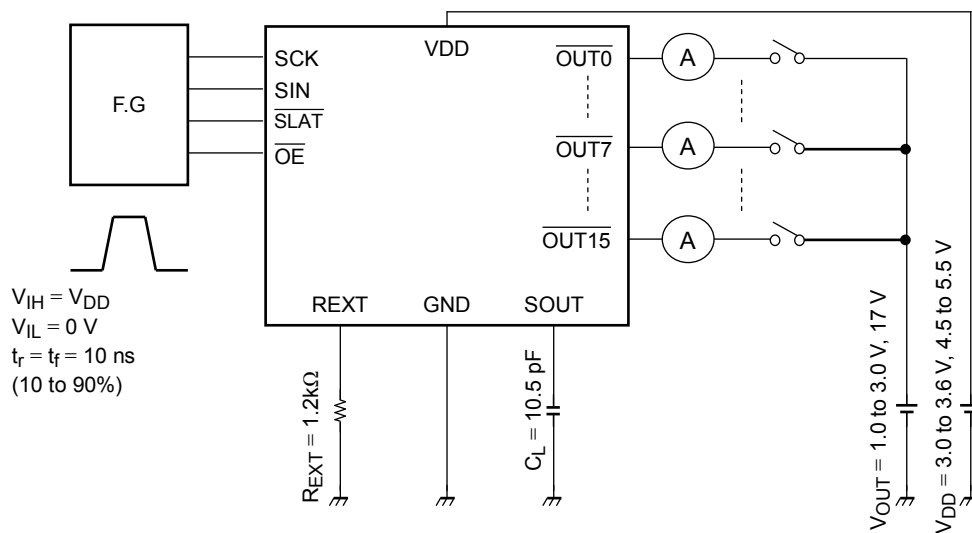


Test Circuit4: Power supply current

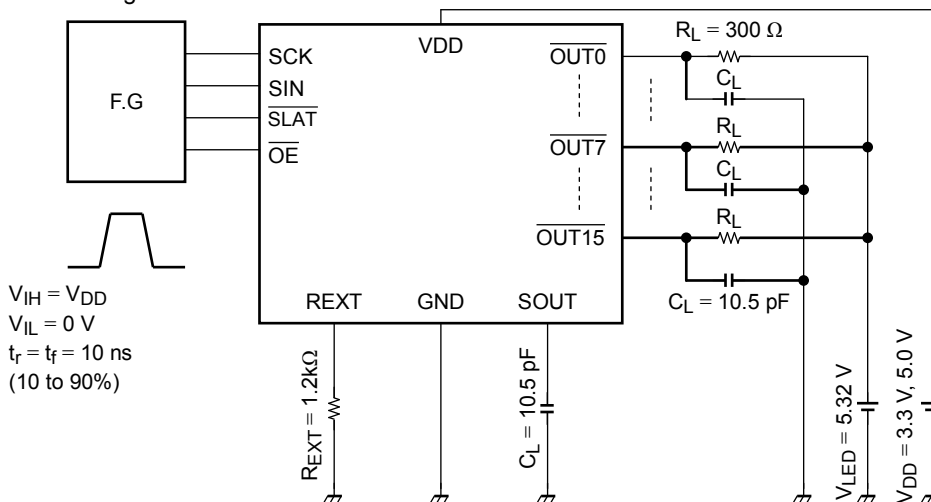


Test Circuit5: Constant current output / Output OFF leak current / Constant current error

Constant current output power supply voltage regulation
Constant current output output voltage regulation

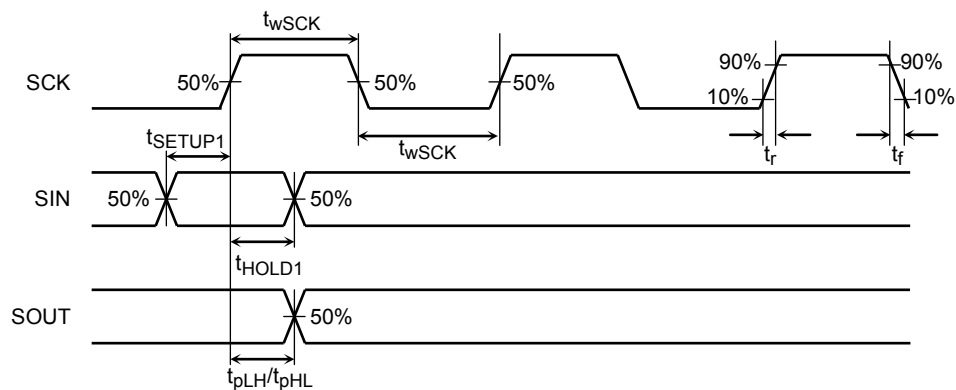


Test Circuit6: Switching Characteristics

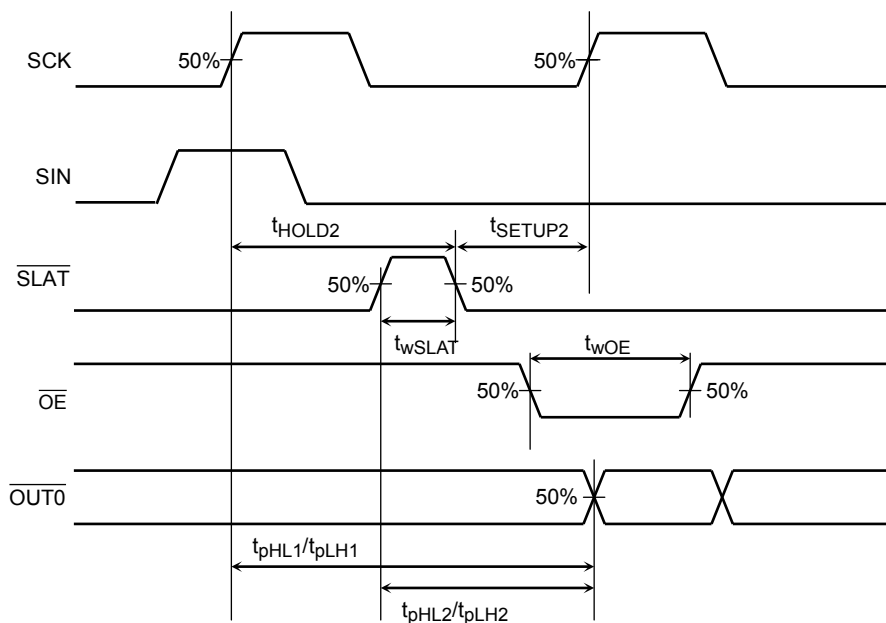


Timing Waveforms

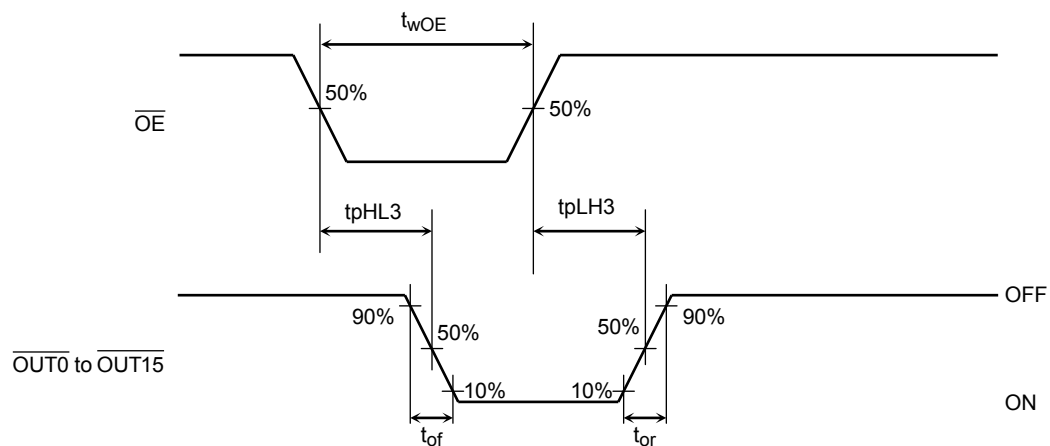
1. SCK, SIN, SOUT



2. SCK, SIN, $\overline{SLAT}$, $\overline{OE}$, $\overline{OUT0}$



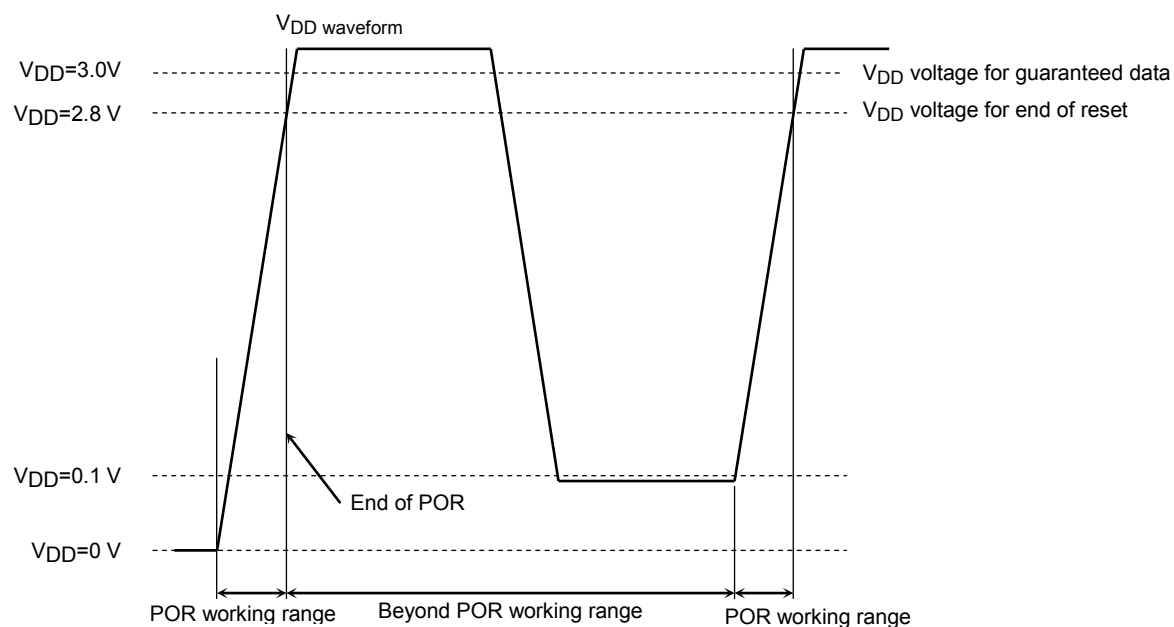
3. $\overline{OE}$, $\overline{OUT0}$ to $\overline{OUT15}$



Power on reset (POR)

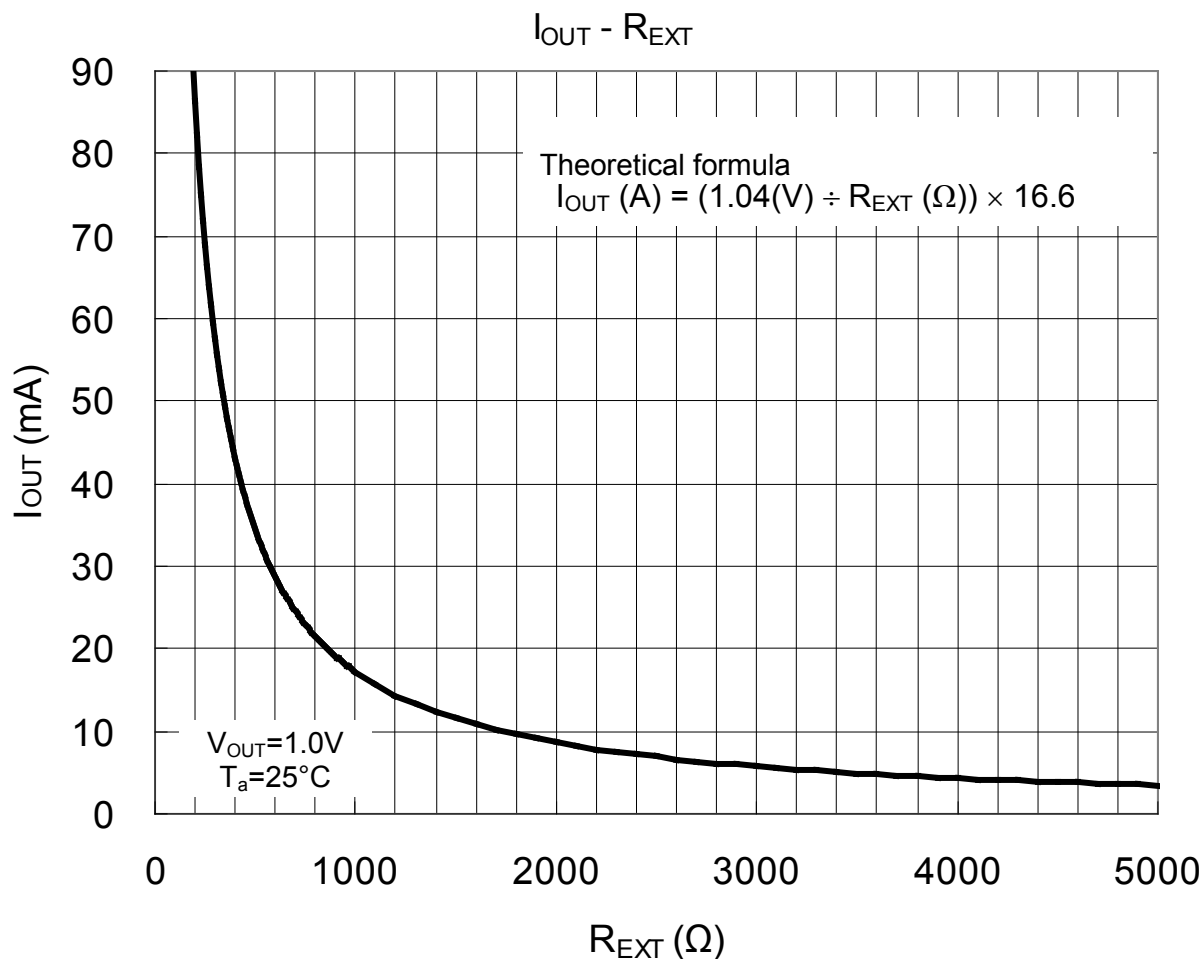
The TC62D748CFG provides a power-on reset to reset all internal data in order to prevent malfunctions.

The POR circuitry works properly only when V_{DD} rises from 0 V. To re-activate the POR circuitry, V_{DD} must be brought to less than 0.1 V. Internal data is guaranteed to be retained after V_{DD} exceeds 3.0 V.



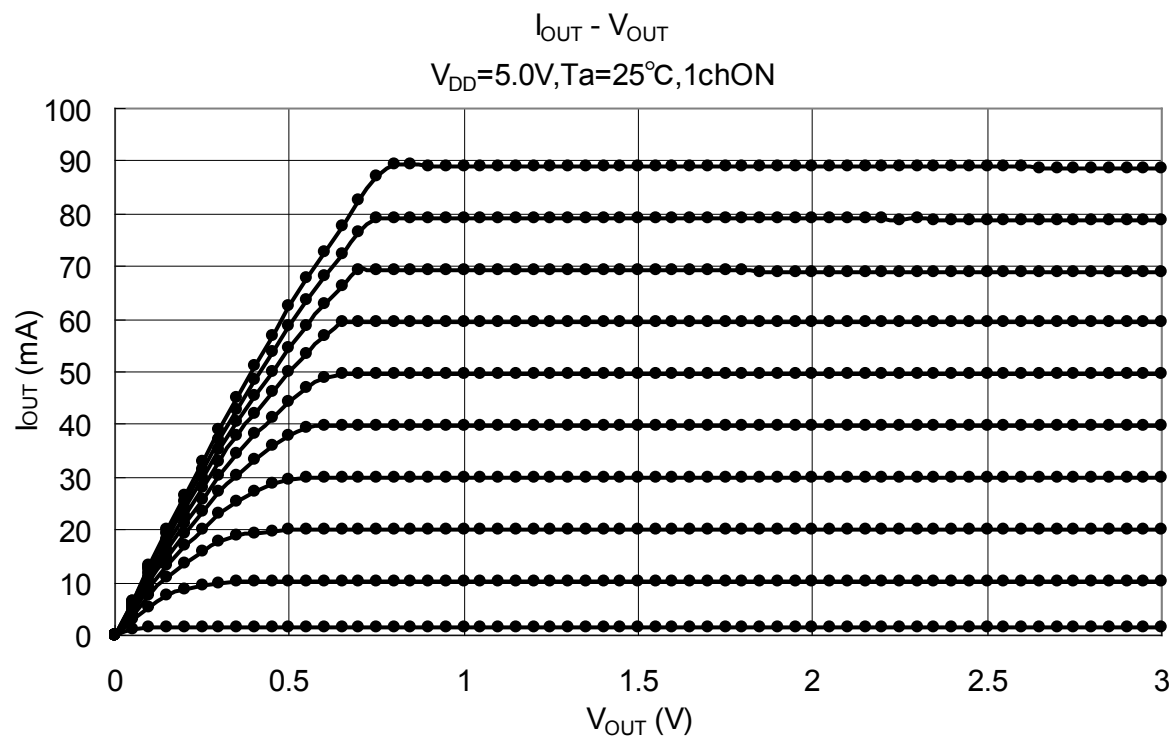
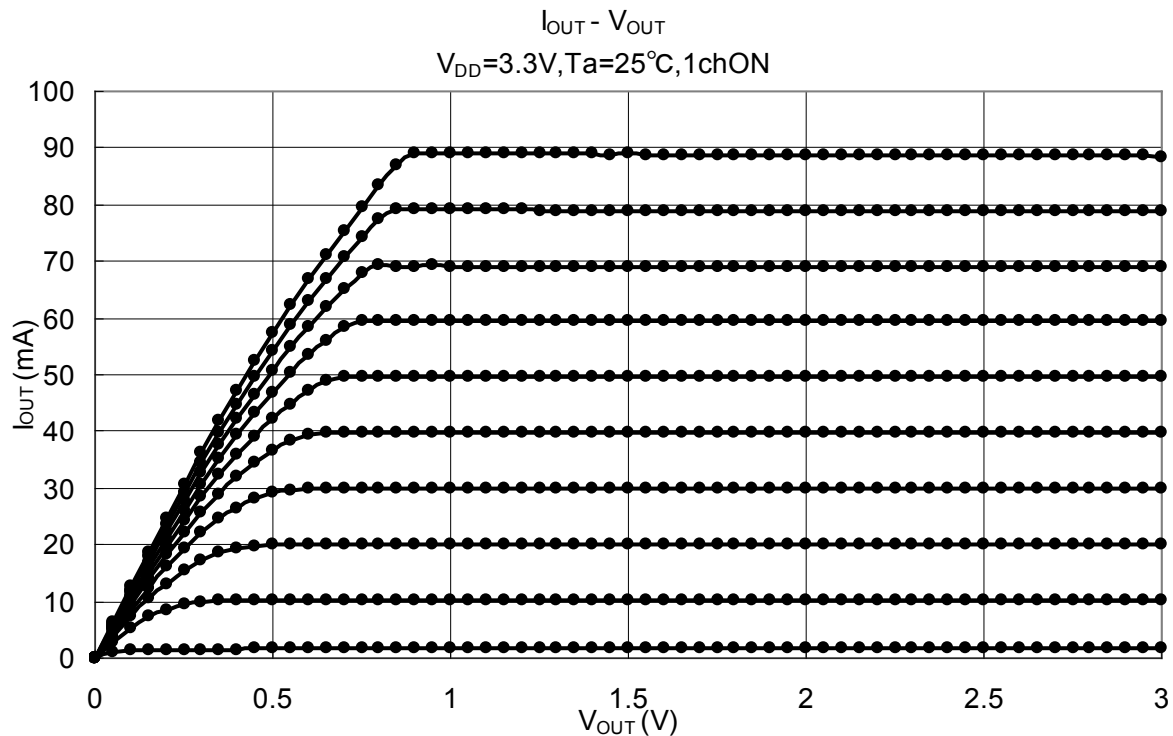
Reference data

The above data is for reference only, not guaranteed. Careful evaluation is required prior to creating a production design.

Output Current (I_{OUT}) – Output current setting resistance (R_{EXT})

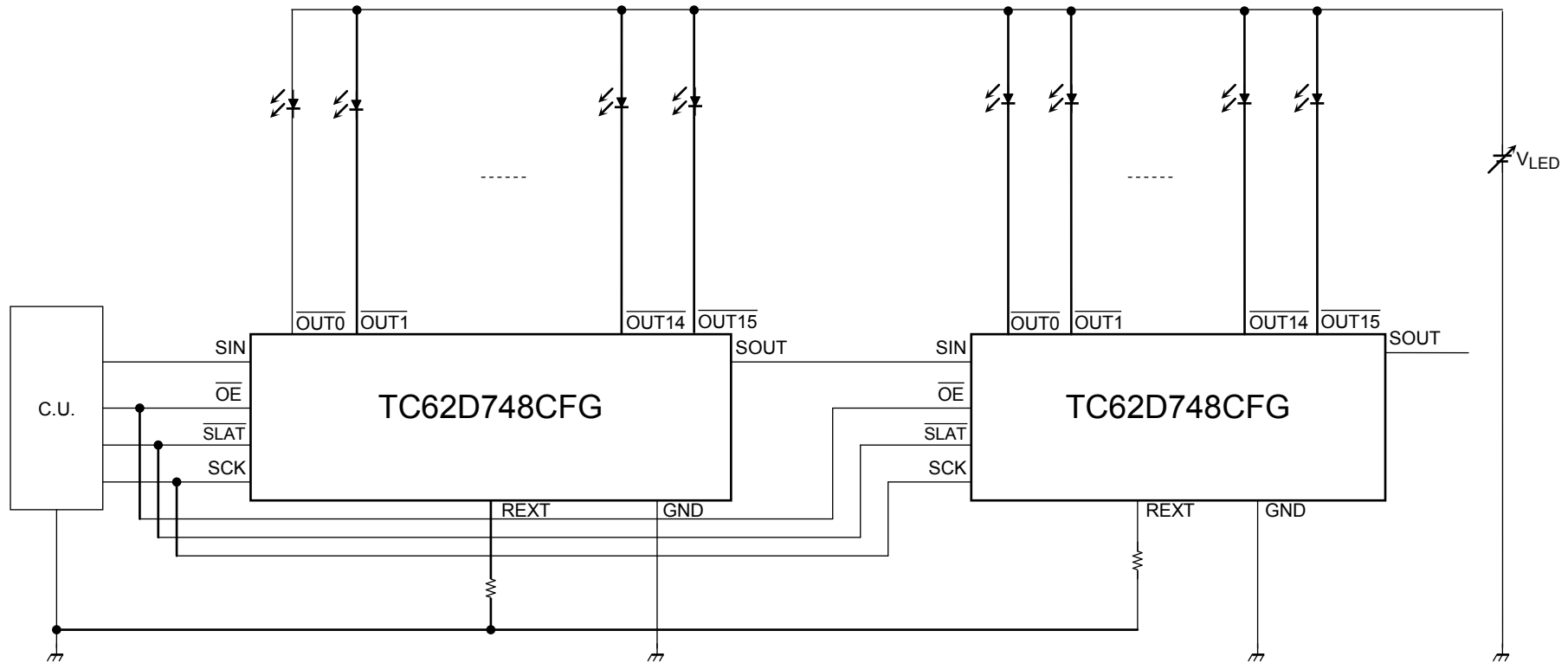
Reference data

The above data is for reference only, not guaranteed. Careful evaluation is required prior to creating a production design.

Output current (I_{OUT}) – Output voltage (V_{OUT})

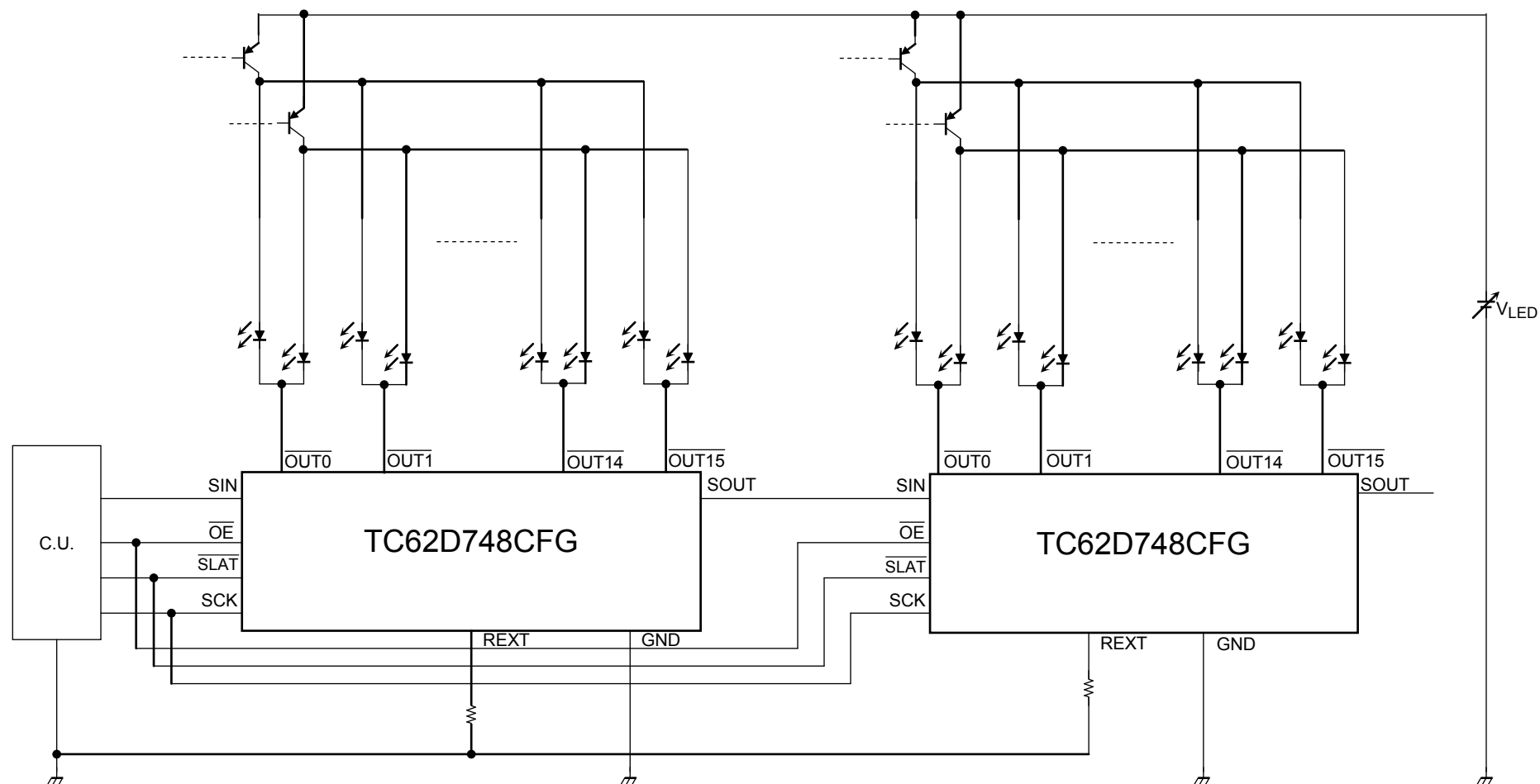
Application Circuit: General Composition for Static Lighting of LEDs

In the following diagram, it is recommended that the LED supply voltage (V_{LED}) be equal to or greater than the sum of V_f (max) of all LEDs plus 1.0 V.



Application Circuit: General Composition for Dynamic Lighting of LEDs

In the following diagram, it is recommended that the LED supply voltage (V_{LED}) be equal to or greater than the sum of V_f (max) of all LEDs plus 1.0 V.



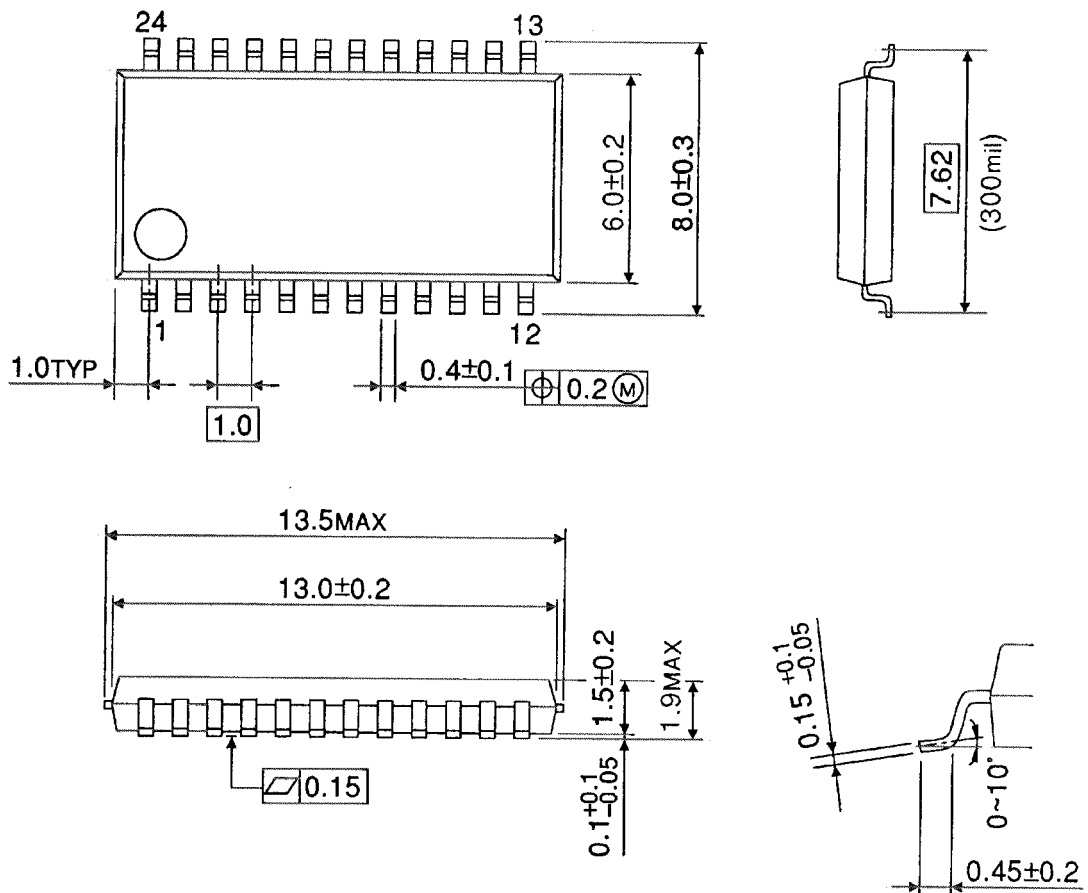
Notes on design of ICs

1. Decoupling capacitors between power supply and GND
It is recommended to place decoupling capacitors between power supply and GND as close to the IC as possible.
2. Output current setting resistors
When the output current setting resistors (R_{EXT}) are shared among multiple ICs, production design should be evaluated carefully.
3. Board layout
Ground noise generated by output switching might cause the IC to malfunction if the ground line exhibits inductance and resistance due to PC board traces and wire leads. Also, the inductance between the IC output pins and the LED cathode pins might cause large surge voltage, damaging LEDs and the IC outputs. To avoid this situation, PC board traces and wire leads should be carefully laid out.
4. Consult the latest technical information for mass production.

Package Dimensions

SSOP24-P-300-1.00B

Unit : mm



Weight: 0.29 g (typ.)

Notes on Contents

1. Block Diagrams

Some of the functional blocks, circuits, or constants in the block diagram may be omitted or simplified for explanatory purposes.

2. Equivalent Circuits

The equivalent circuit diagrams may be simplified or some parts of them may be omitted for explanatory purposes.

3. Timing Charts

Timing charts may be simplified for explanatory purposes.

4. Application Circuits

The application circuits shown in this document are provided for reference purposes only. Thorough evaluation is required, especially at the mass production design stage.

Toshiba does not grant any license to any industrial property rights by providing these examples of application circuits.

5. Test Circuits

Components in the test circuits are used only to obtain and confirm the device characteristics. These components and circuits are not guaranteed to prevent malfunction or failure from occurring in the application equipment.

IC Usage Considerations

Notes on handling of ICs

- [1] The absolute maximum ratings of a semiconductor device are a set of ratings that must not be exceeded, even for a moment. Do not exceed any of these ratings.
Exceeding the rating(s) may cause the device breakdown, damage or deterioration, and may result injury by explosion or combustion.
- [2] Use an appropriate power supply fuse to ensure that a large current does not continuously flow in case of over current and/or IC failure. The IC will fully break down when used under conditions that exceed its absolute maximum ratings, when the wiring is routed improperly or when an abnormal pulse noise occurs from the wiring or load, causing a large current to continuously flow and the breakdown can lead smoke or ignition. To minimize the effects of the flow of a large current in case of breakdown, appropriate settings, such as fuse capacity, fusing time and insertion circuit location, are required.
- [3] If your design includes an inductive load such as a motor coil, incorporate a protection circuit into the design to prevent device malfunction or breakdown caused by the current resulting from the inrush current at power ON or the negative current resulting from the back electromotive force at power OFF. IC breakdown may cause injury, smoke or ignition.
Use a stable power supply with ICs with built-in protection functions. If the power supply is unstable, the protection function may not operate, causing IC breakdown. IC breakdown may cause injury, smoke or ignition.
- [4] Do not insert devices in the wrong orientation or incorrectly.
Make sure that the positive and negative terminals of power supplies are connected properly.
Otherwise, the current or power consumption may exceed the absolute maximum rating, and exceeding the rating(s) may cause the device breakdown, damage or deterioration, and may result injury by explosion or combustion.
In addition, do not use any device that is applied the current with inserting in the wrong orientation or incorrectly even just one time.
- [5] Carefully select external components (such as inputs and negative feedback capacitors) and load components (such as speakers), for example, power amp and regulator.
If there is a large amount of leakage current such as input or negative feedback condenser, the IC output DC voltage will increase. If this output voltage is connected to a speaker with low input withstand voltage, overcurrent or IC failure can cause smoke or ignition. (The over current can cause smoke or ignition from the IC itself.) In particular, please pay attention when using a Bridge Tied Load (BTL) connection type IC that inputs output DC voltage to a speaker directly.

Points to remember on handling of ICs

- (1) Heat Radiation Design
In using an IC with large current flow such as power amp, regulator or driver, please design the device so that heat is appropriately radiated, not to exceed the specified junction temperature (T_J) at any time and condition. These ICs generate heat even during normal use. An inadequate IC heat radiation design can lead to decrease in IC life, deterioration of IC characteristics or IC breakdown. In addition, please design the device taking into consideration the effect of IC heat radiation with peripheral components.
- (2) Back-EMF
When a motor rotates in the reverse direction, stops or slows down abruptly, a current flow back to the motor's power supply due to the effect of back-EMF. If the current sink capability of the power supply is small, the device's motor power supply and output pins might be exposed to conditions beyond absolute maximum ratings. To avoid this problem, take the effect of back-EMF into consideration in system design.

RESTRICTIONS ON PRODUCT USE

- Toshiba Corporation, and its subsidiaries and affiliates (collectively "TOSHIBA"), reserve the right to make changes to the information in this document, and related hardware, software and systems (collectively "Product") without notice.
- This document and any information herein may not be reproduced without prior written permission from TOSHIBA. Even with TOSHIBA's written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before customers use the Product, create designs including the Product, or incorporate the Product into their own applications, customers must also refer to and comply with (a) the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and (b) the instructions for the application with which the Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications, including but not limited to (a) determining the appropriateness of the use of this Product in such design or applications; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample application circuits, or any other referenced documents; and (c) validating all operating parameters for such designs and applications. **TOSHIBA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.**
- **PRODUCT IS NEITHER INTENDED NOR WARRANTED FOR USE IN EQUIPMENTS OR SYSTEMS THAT REQUIRE EXTRAORDINARILY HIGH LEVELS OF QUALITY AND/OR RELIABILITY, AND/OR A MALFUNCTION OR FAILURE OF WHICH MAY CAUSE LOSS OF HUMAN LIFE, BODILY INJURY, SERIOUS PROPERTY DAMAGE AND/OR SERIOUS PUBLIC IMPACT ("UNINTENDED USE").** Except for specific applications as expressly stated in this document, Unintended Use includes, without limitation, equipment used in nuclear facilities, equipment used in the aerospace industry, medical equipment, equipment used for automobiles, trains, ships and other transportation, traffic signaling equipment, equipment used to control combustions or explosions, safety devices, elevators and escalators, devices related to electric power, and equipment used in finance-related fields. **IF YOU USE PRODUCT FOR UNINTENDED USE, TOSHIBA ASSUMES NO LIABILITY FOR PRODUCT.** For details, please contact your TOSHIBA sales representative.
- Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by TOSHIBA for any infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- **ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE FOR PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, TOSHIBA (1) ASSUMES NO LIABILITY WHATSOEVER, INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR LOSS, INCLUDING WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND LOSS OF DATA, AND (2) DISCLAIMS ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO SALE, USE OF PRODUCT, OR INFORMATION, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, ACCURACY OF INFORMATION, OR NONINFRINGEMENT.**
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile technology products (mass destruction weapons). Product and related software and technology may be controlled under the applicable export laws and regulations including, without limitation, the Japanese Foreign Exchange and Foreign Trade Law and the U.S. Export Administration Regulations. Export and re-export of Product or related software or technology are strictly prohibited except in compliance with all applicable export laws and regulations.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. Please use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. **TOSHIBA ASSUMES NO LIABILITY FOR DAMAGES OR LOSSES OCCURRING AS A RESULT OF NONCOMPLIANCE WITH APPLICABLE LAWS AND REGULATIONS.**